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# RENESAS

# HD74ALVCH162244

16-bit Buffers / Drivers with 3-state Outputs

REJ03D0052-0300Z (Previous ADE-205-173A(Z)) Rev.3.00 Oct.02.2003

# Description

The HD74ALVCH162244 is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus oriented receivers and transmitters. The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. It provides true outputs and symmetrical active-low output-enable ( $\overline{OE}$ ) inputs.

To ensure the high impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current sinking capability of the driver.

Active bus hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

All outputs, which are designed to sink up to 12 mA, include 26  $\Omega$  resistors to reduce overshoot and undershoot.

- $V_{CC} = 2.3 \text{ V} \text{ to } 3.6 \text{ V}$
- Typical V<sub>OL</sub> ground bounce < 0.8 V (@V<sub>CC</sub> = 3.3 V, Ta = 25°C)
- Typical  $V_{OH}$  undershoot > 2.0 V (@V<sub>CC</sub> = 3.3 V, Ta = 25°C)
- High output current  $\pm 12 \text{ mA}$  (@V<sub>CC</sub> = 3.0 V)
- Bus hold on data inputs eliminates the need for external pullup / pulldown resistors
- All outputs have equivalent 26  $\Omega$  series resistors, so no external resistors are required.



# **Function table**

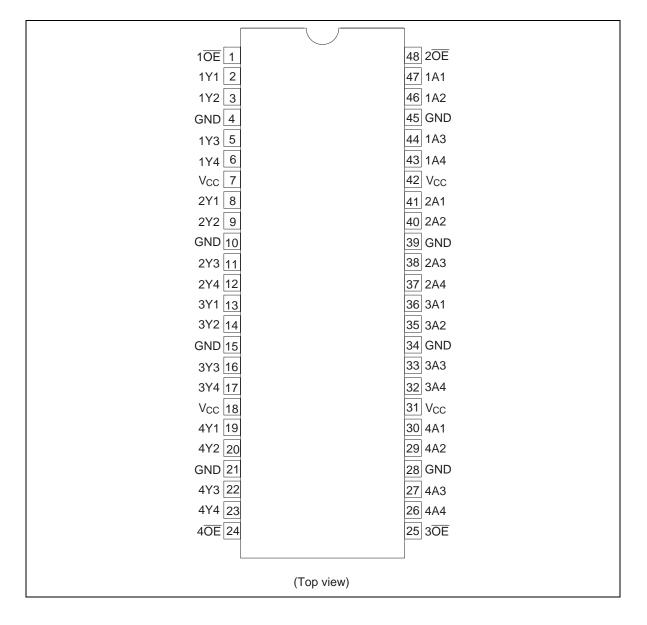
Inputs		Output Y	
ŌĒ	Α		
L	Н	Н	
L	L	L	
Н	Х	Z	

H : High level

L : Low level X : Immaterial

Z : High impedance

# **Pin Arrangement**





Item Symbol		Ratings	Unit	Conditions
Supply voltage	V <sub>CC</sub>	–0.5 to 4.6	V	
Input voltage *1	VI	–0.5 to 4.6	V	
Output voltage *1, 2	Vo	–0.5 to V <sub>CC</sub> +0.5	V	
Input clamp current	I <sub>IK</sub>	-50	mA	V <sub>1</sub> < 0
Output clamp current	I <sub>ОК</sub>	±50	mA	$V_{\rm O}$ < 0 or $V_{\rm O}$ > $V_{\rm CC}$
Continuous output current	lo	±50	mA	$V_{\rm O}$ = 0 to $V_{\rm CC}$
V <sub>CC</sub> , GND current / pin	$I_{CC}$ or $I_{GND}$	±100	mA	
Maximum power dissipation at Ta = $55^{\circ}$ C (in still air) <sup>*3</sup>	P <sub>T</sub>	0.85	W	TSSOP
Storage temperature	Tstg	–65 to 150	°C	

# **Absolute Maximum Ratings**

Notes: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

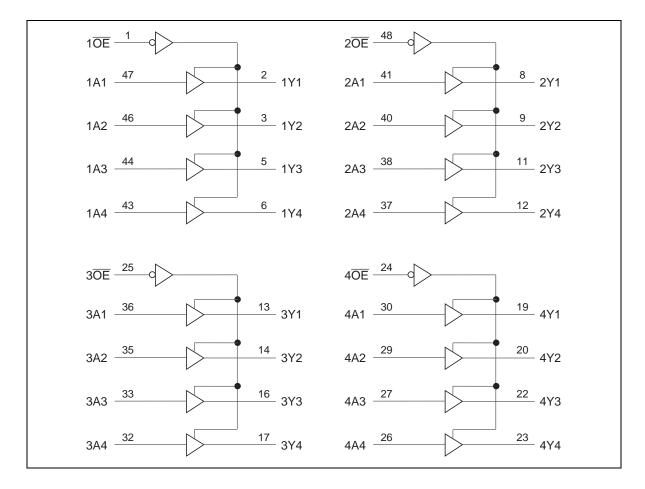
- 1. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
- 2. This value is limited to 4.6 V maximum.
- 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

Item	Symbol	Min	Мах	Unit	Conditions
Supply voltage	Vcc	2.3	3.6	V	
Input voltage	VI	0	V <sub>CC</sub>	V	
Output voltage	Vo	0	V <sub>CC</sub>	V	
High level output current	I <sub>OH</sub>	_	-6	mA	V <sub>CC</sub> = 2.3 V           V <sub>CC</sub> = 2.7 V           V <sub>CC</sub> = 3.0 V           V <sub>CC</sub> = 2.7 V           V <sub>CC</sub> = 2.3 V           V <sub>CC</sub> = 2.3 V           V <sub>CC</sub> = 3.0 V
		_	-8		V <sub>CC</sub> = 2.7 V
		_	–12		V <sub>CC</sub> = 3.0 V
Low level output current	I <sub>OL</sub>	_	6	mA	V <sub>CC</sub> = 2.3 V
		_	8		V <sub>CC</sub> = 2.7 V
		_	12		V <sub>CC</sub> = 3.0 V
Input transition rise or fall rate	$\Delta t$ / $\Delta v$	0	10	ns / V	
Operating temperature	Та	-40	85	°C	

# **Recommended Operating Conditions**

Note: Unused control inputs must be held high or low to prevent them from floating.

# Logic Diagram





# **Electrical Characteristics**

# $(Ta = -40 \text{ to } 85^{\circ}C)$

Item	Symbol	V <sub>cc</sub> (V)	Min	Max	Unit	Test Conditions
Input voltage	VIH	2.3 to 2.7	1.7	_	V	
		2.7 to 3.6	2.0	_	_	
	V <sub>IL</sub>	2.3 to 2.7	_	0.7	_	
		2.7 to 3.6	_	0.8	_	
Output voltage	V <sub>OH</sub>	2.3 to 3.6	V <sub>CC</sub> -0.2	_	V	I <sub>OH</sub> = –100 μA
		2.3	1.9	_	_	I <sub>OH</sub> = –4 mA, V <sub>IH</sub> = 1.7 V
		2.3	1.7	_	_	I <sub>OH</sub> = –6 mA, V <sub>IH</sub> = 1.7 V
		3.0	2.4	_	_	$I_{OH}$ = -6 mA, $V_{IH}$ = 2.0 V
		2.7	2.0	_	_	$I_{OH}$ = -8 mA, $V_{IH}$ = 2.0 V
		3.0	2.0	_	_	I <sub>OH</sub> = -12 mA, V <sub>IH</sub> = 2.0 V
	V <sub>OL</sub>	2.3 to 3.6		0.2	_	I <sub>OL</sub> = 100 μA
		2.3		0.4	_	$I_{OL}$ = 4 mA, $V_{IL}$ = 0.7 V
		2.3	_	0.55	_	$I_{OL}$ = 6 mA, $V_{IL}$ = 0.7 V
		3.0		0.55	_	$I_{OL}$ = 6 mA, $V_{IL}$ = 0.8 V
		2.7		0.6	_	I <sub>OL</sub> = 8 mA, V <sub>IL</sub> = 0.8 V
		3.0		0.8	_	$I_{OL}$ = 12 mA, $V_{IL}$ = 0.8 V
Input current	I <sub>IN</sub>	3.6		±5	μA	$V_{IN} = V_{CC}$ or GND
	IIN (hold)	2.3	45	_	_	V <sub>IN</sub> = 0.7 V
		2.3	-45	_	_	V <sub>IN</sub> = 1.7 V
		3.0	75	_	_	V <sub>IN</sub> = 0.8 V
		3.0	-75	_	_	V <sub>IN</sub> = 2.0 V
		3.6	_	±500		$V_{IN} = 0$ to 3.6 V <sup>*1</sup>
Off state output current	l <sub>oz</sub>	3.6	_	±10	μA	$V_{OUT} = V_{CC}$ or GND
Quiescent supply current	I <sub>CC</sub>	3.6		40	μA	$V_{IN} = V_{CC}$ or GND
	$\Delta I_{CC}$	3.0 to 3.6	—	750	μA	$V_{IN}$ = one input at (V <sub>CC</sub> -0.6) V, other inputs at V <sub>CC</sub> or GND

Notes: 1. This is the bus hold maximum dynamic current required to switch the input from one state to another.

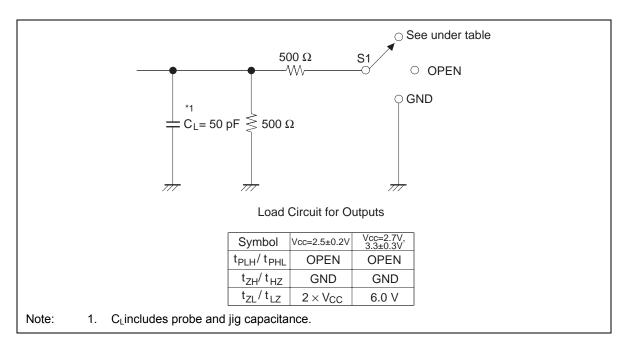


# **Switching Characteristics (cont)**

# $(Ta = -40 \text{ to } 85^{\circ}C)$

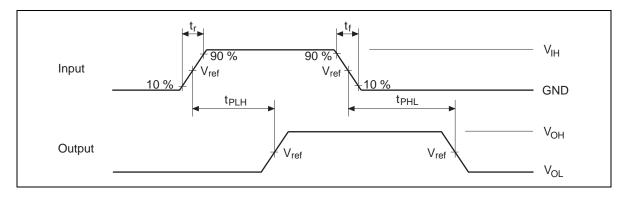
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Мах	Unit	FROM (Input)	TO (Output)
Propagation delay time	t <sub>PLH</sub>	2.5±0.2	1.0	—	4.9	ns	А	Y
	t <sub>PHL</sub>	2.7			4.7			
		3.3±0.3	1.0	—	4.2	_		
Output enable time	t <sub>ZH</sub>	2.5±0.2	1.0	—	6.8	ns	OE	Y
	t <sub>ZL</sub>	2.7			6.7			
		3.3±0.3	1.0	—	5.6	_		
Output disable time	t <sub>HZ</sub>	2.5±0.2	1.0	—	6.3	ns	OE	Y
	t <sub>LZ</sub>	2.7		_	5.7			
		3.3±0.3	1.0	—	5.5	_		
Input capacitance	CIN	3.3		3.0	—	pF	Control inputs	
		3.3		6.0	—	_	Data inpu	ts
Output capacitance	Co	3.3		7.0		pF	Outputs	

# **Test Circuit**

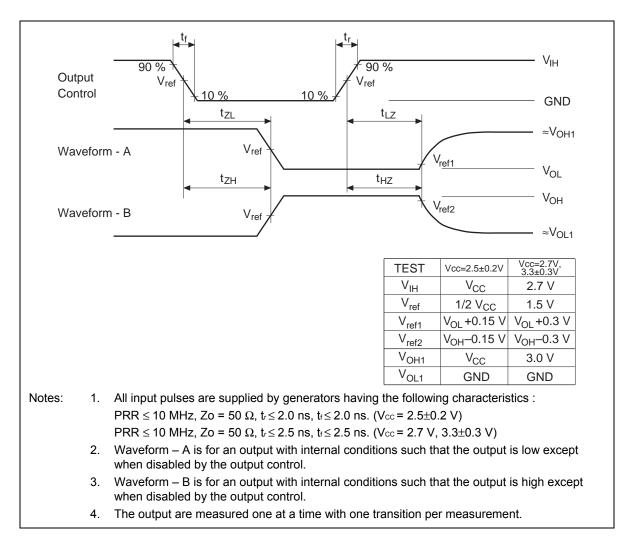




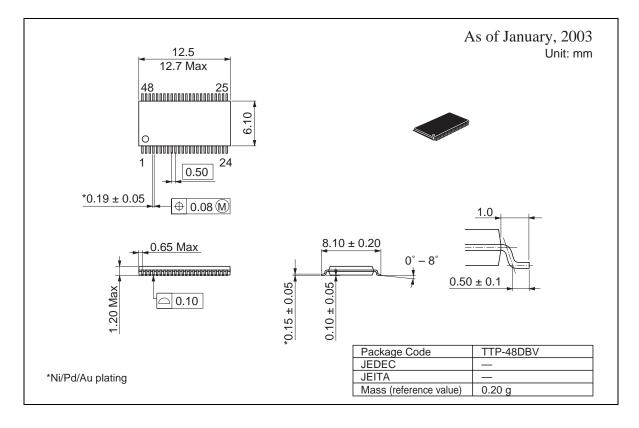
### Waveforms – 1



### Waveforms – 2



# **Package Dimensions**





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